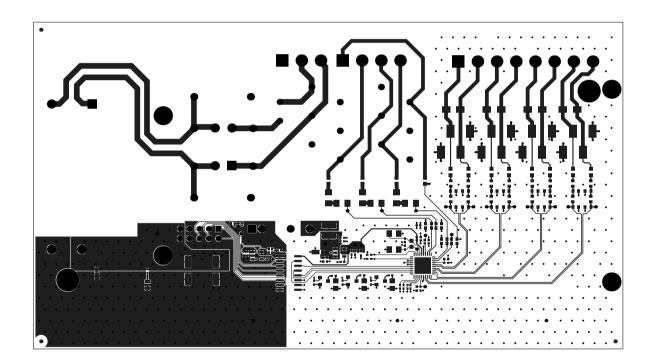


Layer	Name	Material	Thickness	Constant
	Top Overlay			
	Top Solder	Solder Resist	O. 010mm	3.5
1	Top Layer		O.018mm	
	Dielectric 2	PP-006	0.249mm	4.1
2	GND	CF-004	0.035mm	
	Dielectric 1	FR-4	0.960mm	4.8
3	PWR	CF-004	0.035mm	
	Dielectric 3	PP-006	0.249mm	4.1
4	Bottom Layer		O.018mm	
	Bottom Solder	Solder Resist	O. 010mm	3.5
	Bottom Overlay			

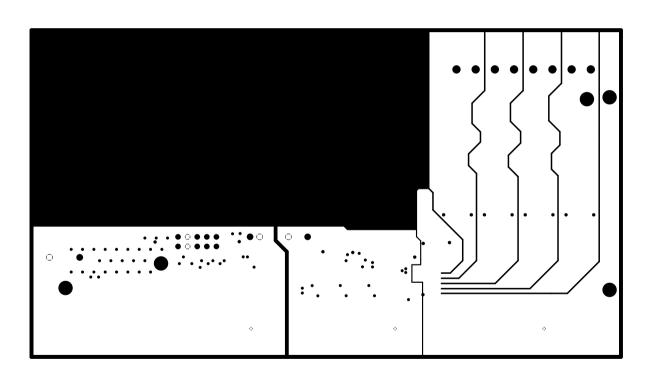
Symbol	Count	Hole Size	Plated	Hole Type
0	2	0.800mm (31.50mil)	PTH	Round
₹	4	1.100mm (43.31mil)	PTH	Round
▽	4	1.150mm (45.28mil)	PTH	Round
	6	3.200mm (125.98mil)	PTH	Round
×	8	1.000mm (39.37mil)	PTH	Round
Ħ	10	0.900mm (35.43mil)	PTH	Round
0	15	1.600mm (62.99mil)	PTH	Round
♦	16	1.200mm (47.24mil)	PTH	Round
	38	0.300mm (11.81mil)	PTH	Round
0	618	0.200mm (7.87mil)	PTH	Round
	721 Total			

RBZ Embedded Logics
Ref.: DAEMON-LEC-5G-DOWN_IND_00
Layer: Dirill / pelifations
Date: 21/03/2024
Dibujado: D.Lara



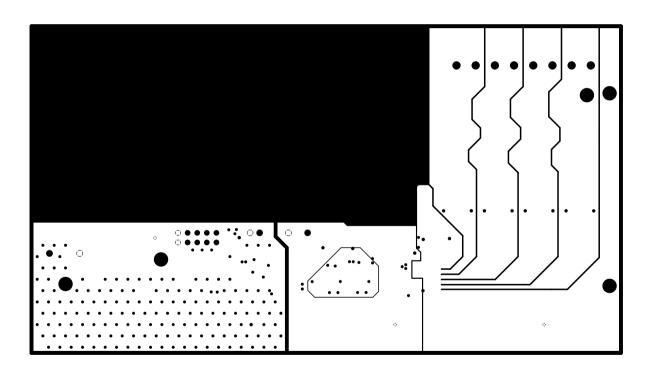
RBZ Embedded Logics

Ref.: DAEMON-LEC-5G-DOWN_IND_00
Layer: 1.Top Layer
Date: 21/03/2024
Dibujado: D.Lara



RBZ Embedded Logics

Ref.: DAEMON-LEC-5G-DOWN_IND_00 Layer: 2.Top Plane Date: 21/03/2024 Dibujado: D.Lara



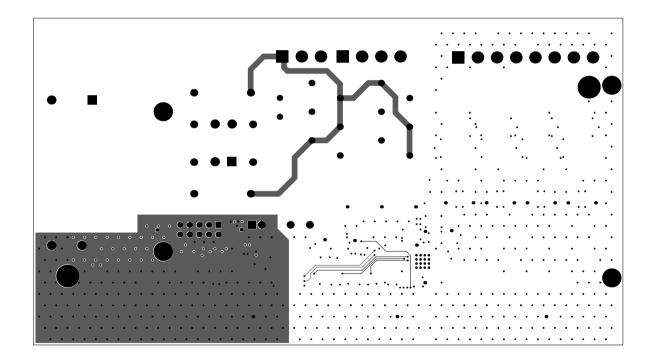
 RBZ
 Embedded Logics

 Ref.:
 DAEMON-LEC-5G-DOWN_IND_00

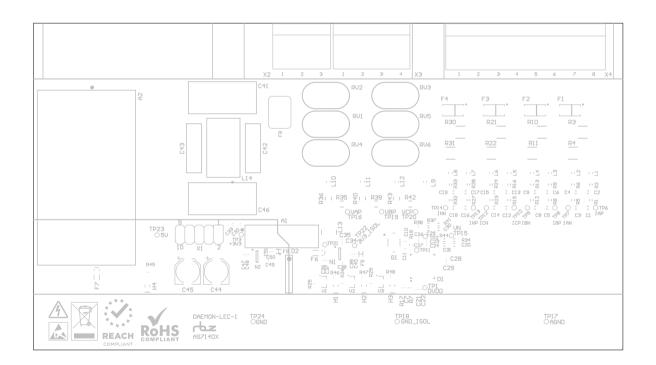
 Layer:
 3.Bottom Plane

 Date:
 21/03/2024

 Dibujado:
 D.Lara

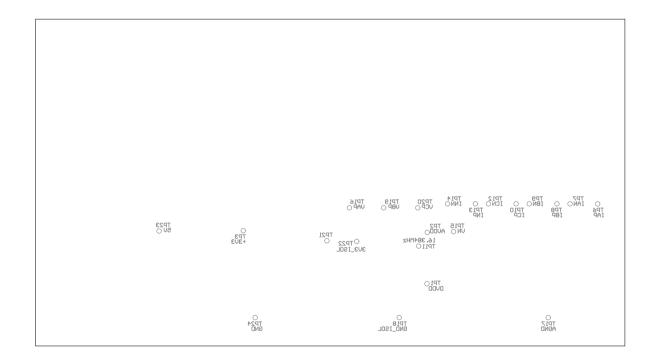


RBZ Embedded Logics
Ref.: DAEMON-LEC-5G-DOWN_IND_00
Layer: 4.Bottom Layer
Date: 21/03/2024
Dibujado: D.Lara

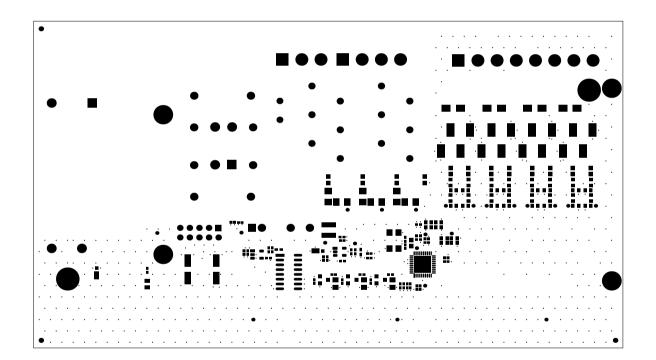


RBZ Embedded Logics

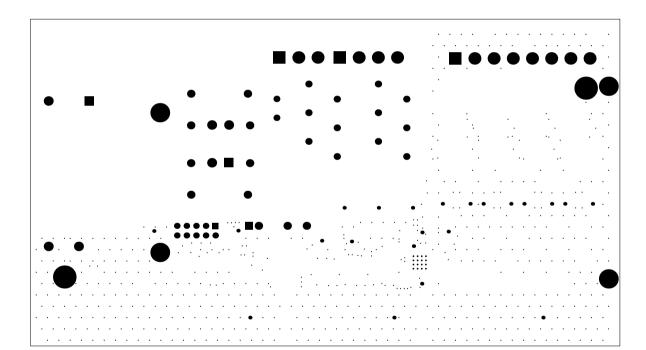
Ref.: DAEMON-LEC-5G-DOWN_IND_00
Layer: Top Oerlay
Date: 21/03/2024
Dibujado: D.Lara



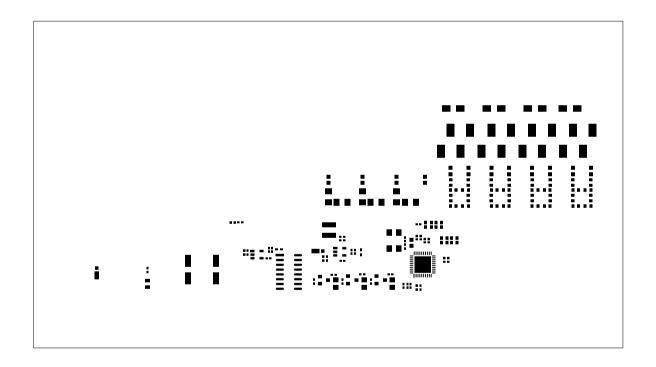
RBZ Embedded Logics
Ref.: DAEMON-LEC-5G-DOWN_IND_00
Layer: Bottom Oerlay
Date: 21/103/2024
Dibujado: D.Lara



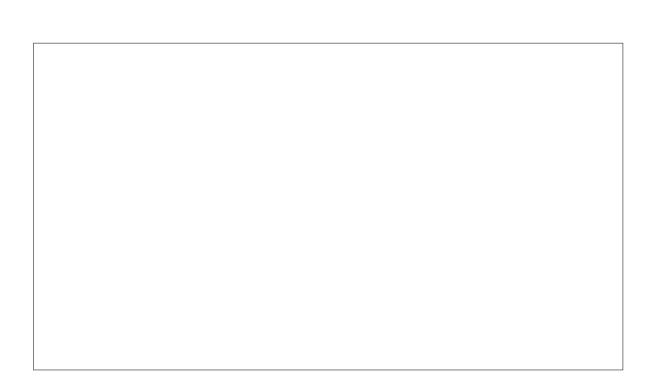
RBZ Embedded Logics
Ref.: DAEMON-LEC-5G-DOWN_IND_00
Layer: Top older
Date: 21/03/2024
Dibujado: D.Lara



RBZ Embedded Logics
Ref.: DAEMON-LEC-5G-DOWN_IND_00
Layer: Bottom older
Date: 21/03/2024
Dibujado: D.Lara



RBZ Embedded Logics
Ref.: DAEMON-LEC-5G-DOWN_IND_00
Layer: Top Paste
Date: 21/03/2024
Dibujado: D.Lara



RBZ Embedded Logics
Ref: DAEMON-LEC-5G-DOWN_IND_00
Layer: Bottom Paste
Date: 21/03/2024
Dibujado: D.Lara